

MC33PF8200DGES

MC33PF8200DGES Information

- Bootstand	Part Number Manufacturer Category Description Package	MC33PF8200DGES NXP Integrated Circuits (ICs) PMIC - Power Management - Specialized IC POWER MANAGEMENT I.MX8QM 56-VFQFN Exposed Pad For the pricing/inventory/lead time, please contact	
For Reference O	nly	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



MC33PF8200DGES Specifications

Manufacturer Part Number	MC33PF8200DGES
Manufacturer	NXP
Category	Integrated Circuits (ICs)
	PMIC - Power Management - Specialized
Package	56-VFQFN Exposed Pad
Series	-
Applications	High Performance i.MX 8, S32x Processor Based
Current - Supply	-
Voltage - Supply	2.5V ~ 5.5V
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount, Wettable Flank
Package / Case	56-VFQFN Exposed Pad
Supplier Device Package	56-HVQFN (8x8)
	Report errors?

MC33PF8200DGES Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

MC33PF8200DGES Payment Methods





If you have any question about MC33PF8200DGES, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com